FORM PTO-1984	ההקטיי זינטון בטו	M COMPD	CHEET	U.S. DEPARTMENT OF COMMERC
SON-1722 1. 33	05-26-2	000	Patent and Trademark Of	fice
To the Honorable Commissioner of Patents ε			iginal documents or copy	thereof.
Name of conveying party(ies) Katsunori SENO Takahiro SEKI	1013681		ress of receiving party(ies)
3) Tetsuo KONDO		nternal Addr		
Additional name(s) of conveying party(ies) att	ached No			
3. Nature of conveyance: ☑ Assignment ☐ Merg	MAY 2 3 2000	treet Addres	s: 7-35 KITASHINAGAW V A-K U	'A 6-CHOME ,
	13 8	City: TOKY	O, JAPAN	
☐ Security Agreement ☐ Chang	ge of Name	Additional na	me(s) & address(es) attached	□ Yes ⊠ No
Other				
Execution Date: May 17, 2000 (1-3)				
4. Application number(s) or patent number(s)	09/484,240			
If the document is being	g filed together with a new a Additional numbe		e execution date of the applica <u>No</u>	ition is
Name and address of party to whom correst document should be mailed:	spondence concerning (ó. Total num	ber of applications and patents	involved: 1
Name: Ronald P. Kananen, E	Esq.	7. Total fee ((37 CFR 3.41)\$	40.00
Internal Address: RADER, FISHMAN	& GRAUER	□ Encl	osed	
Suite 501		⊠ Authori	zed to be charged to Deposit A	Account
Street Address: 1233 20th Street, NW	1	3. Deposit ac	ecount number:	
City: Washington, D.C. Zi	p: 20036	(Attach du	18-0013 aplicate copy of this page if page	ying by deposit account)
DO NOT USE THIS SPACE				
9. Statement and signature. To the best of my knowledge and belief, the document.	ne foregoing information is	true and corre	ect and any attached copy is a	true copy of the original
Ronald P. Kananen Name of Person Signing Total number of pages comprising cover sheet			May 23, 200 Date	
	1 ASSIG	NEE		
24/2000 TLUU11 00000124 180013 09484240				
FC:581 40.00 CH				

PATENT REEL: 010807 FRAME: 0235

Docket Number: SON-1722

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in SEMICONDUCTOR DEVICE REPLICA CIRCUIT FOR MINITORING CRITICAL PATH AND

CONSTITUTION METHOD OF THE SAME

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/484,240, Filing Date: Jan. 18,2000.

This assignment executed on the dates indicated below.

KATSUNORI SENO	
Name of first or sole inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of first or sole inventor	
forten Son	May 17, 2000
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 010807 FRAME: 0236

TAKAHIRO SEKI	
Name of second inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of second inventor	
Takahvro Sehi	May 17,2000
Signature of second inventor	Date of this assignment
TETSUO KONDO	
Name of third inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of third inventor	4.1
Tetous Mondo	May 17, 2000
Signature of third inventor	May 17, 2 cco Date of this assignment
Name of fourth inventor	Execution date of J.S. Patent Application
Nume of loaffi inventor	Execution date of 9.3. I atent Application
Residence of fourth inventor	
residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
of intil inventor	Execution date of O.S. I atent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

RECORDED: 05/23/2000

PATENT REEL: 010807 FRAME: 0237